SPEC. No. ED-04P078A ISSUE September 14, 2005

SHARP

OPTO-ELECTRONIC DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

SPECIFICATION

·		
	PHOTOTRIAC COUPLER	
MODEL No.		
	3SD12	
	Business dealing name	
	PC3SD12NTZAF PC3SD12YTZAF	
Specified for		
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SHARP CORPORATION



Product name: PHOTOTRIAC COUPLER

Model No.: 3SD12

(Business dealing name: PC3SD12NTZAF) (Business dealing name: PC3SD12YTZAF)

- 1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas;
 - OA equipment · Audio visual equipment · Home appliances
 - · Telecommunication equipment (Terminal) · Measuring equipment
 - · Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
 - Transportation control and safety equipment (aircraft, train, automobile etc.)
 - · Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
 - · Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
 - Space equipment Telecommunication equipment (for trunk lines)
 - · Nuclear power control equipment · Medical equipment
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.



1. Application

This specification applies to the outline and characteristics of phototriac coupler Model No. 3SD21 (Apply line voltage 200V AC).

2. Outline

Refer to the attached sheet, page 4.

3. Ratings and characteristics

Refer to the attached sheet, page 5, 6.

4. Reliability

Refer to the attached sheet, page 7.

5. Outgoing inspection

Refer to the attached sheet, page 8.

6. Supplement

6.1 Business dealing name

("O" mark indicates business dealing name of ordered product)

Product Business dealing name		Remarks
	PC3SD12NTZAF	
PC3SD12YTZAF		*Applied to products as an option (Attachment-1-1 to 1-3)

6.2 Package specification

Refer to the attached sheet, page 9,10.

- 6.3 Isolation voltage shall be measured in the following method.
 - (1) Short between pins 1 to 3 on the primary side and between pins 4 to 6 on the secondary side.
 - (2) The dielectric withstanding tester with zero-cross circuit shall be used.
 - (3) The wave form of applied voltage shall be a sine wave.

(It is recommended that the isolation voltage be measured in insulation oil.)

6.4 This Model is approved by UL and CSA.

Approved Model No.: 3SD12

UL file No.: E64380

CSA file No.: CA95323

CSA approved mark " shall be indicated on minimum unit package.

6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.6 ODS materials

This product shall not contain the following materials.

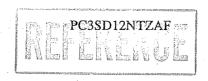
Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC_S, Halon, Carbon tetrachloride,

1.1.1-Trichloroethane (Methyl chloroform)

6.7 Brominated flame retardants

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.



7. Notes

- 7.1 Circuit design
- (1) The LED used in the Phototriac coupler generally decreases the light emission power by operation. In case of long operation time, please decide I_F value so that I_F is more than 2 times of the Maximum value of the Minimum triggering current at circuit design with considering the decreases of the light emission power of the LED. (50% / 5years)
- (2) Input current (I_F) at off state shall be set 0.1mA or less.
- (3) In case that pulse drive is carried out, the pulse width of input signal should be 1ms or more.
- 7.2 Usage

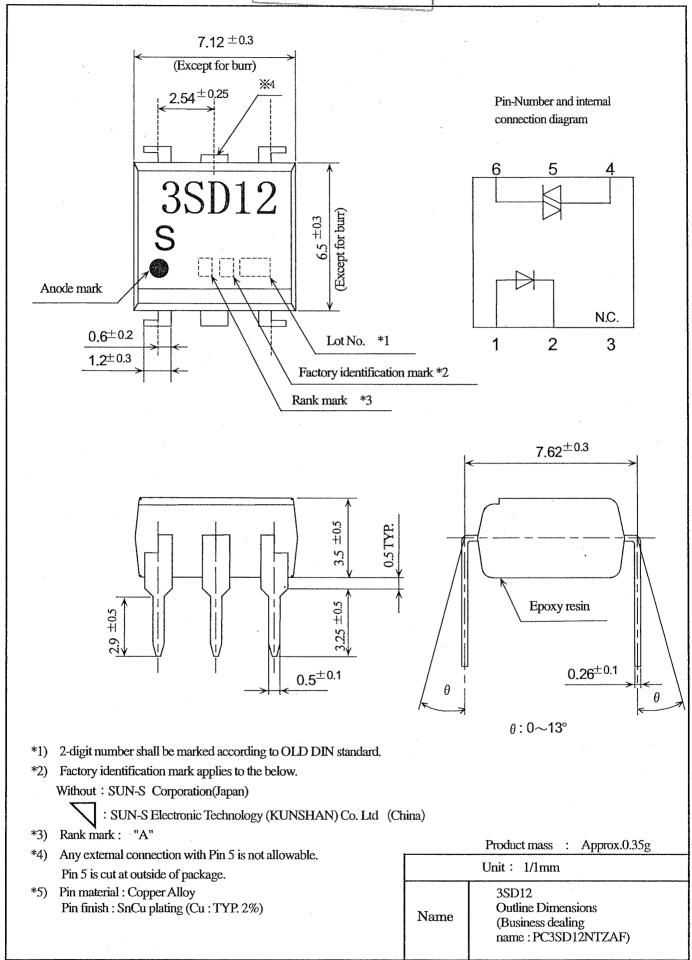
For triggering medium and high power triac.

(This model shall be used under the conditions on which power triac turns on.)

- 7.3 Ceaning
- (1) Solvent cleaning: Solvent temperature 45°C or less, Immersion for 3 min or less
- (2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition and confirm that any defect doesn't occur before starting the ultrasonic cleaning.
- (3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol
 When the other solvent is used, there are cases that the packaging resin is eroded.
 Please use the other solvent after thorough confirmation is performed in actual using condition.
- 7.4 Precautions for Soldering Phototriac couplers
- (1) In case of flow solder (Whole dipping is possible) It is recommended that flow soldering be carried out at 270°C or less and within 10s (Pre-heating: 100 to 150°C, 30 to 80s): Within 2 times
- (2) It is recommended that hand soldering be carried out at 400°C or less and within 3s: Within 2 times
- (3) Other notes

Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to junction between PCB and lead pins of photocoupler is different. Please confirm that there is no problem on the actual use conditions.







3.1 Absolute maximum ratings

Ta=25℃

	Parameter	Symbol	Rating	Unit
Input	Forward current *1	$I_{\rm F}$	50	mA
mput	Reverse voltage	V_R	6	V
	RMS on-state current *1	I _T (rms)	0.1	A
Output	Peak one cycle surge current	Isurge	1.2 (50Hz sine wave)	A
	Repetitive peak off-state voltage	V_{DRM}	600	V
Isolation voltage *2		Viso(rms)	5	kV
Operating temperature		Topr	-30 to +100	$^{\circ}\! \mathbb{C}$
	Storage temperature	Tstg	-55 to +125	$^{\circ}$ C
	Soldering temperature	Tsol	270 (For 10s)	$^{\circ}$

^{*1} The derating factors of absolute maximum rating due to ambient temperature are shown in Fig.1, 2.

3.2 Electrical characteristics

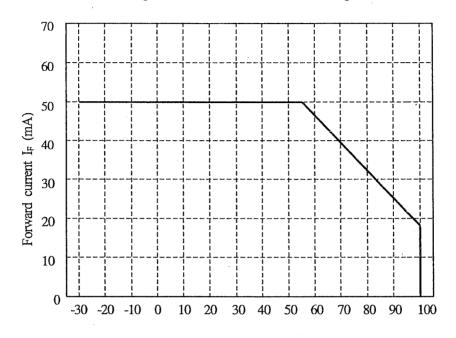
Ta=25°C

Parameter Symbol MIN. TYP.						** **	
	Parameter		MIN.	TYP.	MAX.	Unit	Conditions
Input	Forward voltage	V_{F}	-	1.2	1.4	V	I _F =20mA
при	Reverse current	I_R	_	-	10 ⁻⁵	A	V _R =3V
	Repetitive peak	Ť		-	10 ⁻⁶		X7X7
	off-state current	I_{DRM}	-			A	V _D =V _{DRM}
Output	On-state voltage	V _T	-	-	2.5	V	I _T =0.1A
Output	Holding current	$I_{\rm H}$	0.1	-	3.5	mA	V _D =6V
	Critical rate of rise	dv/dt	1000	2000	-	V/μs	$V_D=1/\sqrt{2} \cdot V_{DRM}$
	of off-state voltage	. av/at					
Tennafor	Minimum trigger current	I_{FT}	-	-	10	mA	$V_D = 6V, R_L = 100 \Omega$
Transfer charac-	Isolation resistance	R _{ISO}	5×10 ¹⁰	10 ¹¹	-	Ω	DC500V 40 to 60%RH
teristics	Them on time	t _{on}	-	_	50	μS	$V_D = 6V, R_L = 100 \Omega,$
tensues	Turn on time						I _F =20mA

^{*2} AC for 1min, 40 to 60%RH, f=60Hz

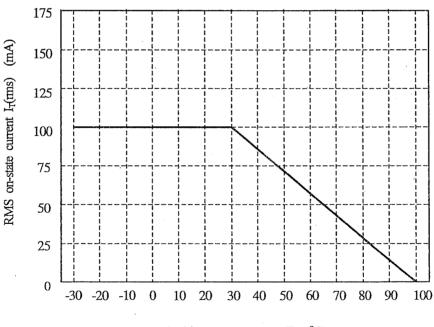


Fig.1 Forward current vs. ambient temperature

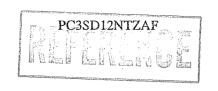


Ambient temperature Ta (°C)

Fig.2 RMS on-state current vs. ambient temperature



Ambient temperature Ta (°C)



4. Reliability

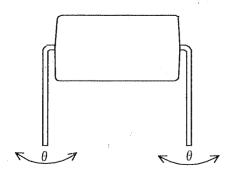
The reliability of products shall satisfy items listed below.

Confidence level: 90%

LTPD: 10 or 20

		LIFD.		
Test Items	Test Conditions *1	Failure Judgement	Samples (n)	
rest tieris	Test Conditions 1	Criteria	Defective(C)	
Solderability *2	245±3℃, 5s		n=11, C=0	
Soldering heat *3	(Flow soldering) 270°C, 10 s		n=11, C=0	
Soldering heat	(Soldering by hand) 400°C, 3 s		n 11, C 0	
Terminal strength	Weight: 5.0N		n=11, C=0	
(Tension)	5 s/each terminal	***	11-11, C-0	
Terminal strength	Weight: 2.5N	$V_F>U\times 1.2$	n=11, C=0	
(Bending) *4	2 times/each terminal	V S V V 1 O	11-11, C-0	
Mechanical shock	15km/s ² , 0.5ms	$V_T>U\times 1.2$	-11 (-0	
IVICCIIAIIICAI SHOCK	3 times/ \pm X, \pm Y, \pm Z direction	$I_{FT}>U\times1.3$	n=11, C=0	
Variable frequency	100 to 2000 to 100Hz/4min	IFT > U \ 1.3		
variable frequency	200m/s ²	$I_R>U\times 2.0$	n=11, C=0	
VIOLAGOII	4 times/X, Y, Z direction	IR > 0 × 2.0	,	
	1 cycle -55°C to +125°C	$I_{DRM}>U\times2.0$		
Temperature cycling	(30min) (30min)	DRW 5 7 (2.0	n=22,C=0	
	20 cycles test Without Load	U: Upper specification limit		
High temp. and high	+85°C, 85%RH, 500h		n=22,C=0	
humidity storage	· 65 C, 65 /6141, 50011	L: Lower specification limit	11-22,0-0	
High temp. storage	+125°C, 1000h	_	n=22,C=0	
Low temp. storage	-55℃, 1000h		n=22,C=0	
Operation life	I _F =50mA, I _I =100mA		n=22,C=0	
Operation inc	Ta=25°C, 1000h		11-22,0-0	

- *1 Test method, conforms to EIAJ ED 4701.
- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- *3 Dip into the position of 1.0mm from the resin part.
- *4 Terminal bending direction is shown below.





5. Outgoing inspection

- 5.1 Inspection items
 - (1) Electrical characteristics $V_{F}, I_{R}, I_{DRM}, V_{T}, I_{FT}, R_{ISO}, Viso \label{eq:VF}$
 - (2) Appearance

5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25



6.2 Package specification

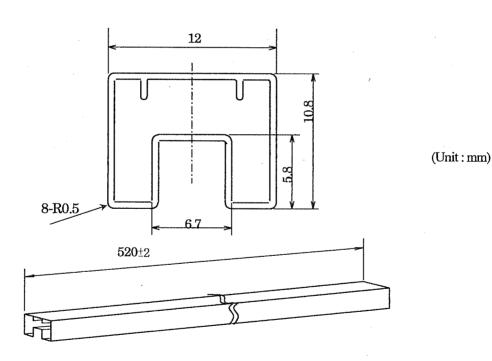
6.2.1 Package materials

No.	Name	Materials	Purposes		
1	Sleeve	HIPS with preventing static electricity	Products packaged		
2	Stopper	Styrene-Elastomer	Products fixed		
3	Packing case	Corrugated cardboard	Sleeve packaged		
4	Kraft tape	Paper	Lid of packaged case fixed		
5			Model No. (Business dealing name), lot No., quantity, country of origin, Company name and inspection date specified		

6.2.2 Package method

- (1) MAX. 50pcs. of products shall be packaged in a sleeve and both of sleeve edges shall be fixed by stoppers.
- (2) MAX. 20 sleeves above shall be packaged in a packing case and pack a sheet of cushion at one side.
- (3) The label shall be put on the side of the packaging case.
- (4) Case shall be closed with the lid and enclosed with kraft tape.

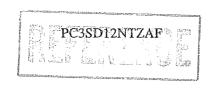
6.2.3. Sleeve drawing



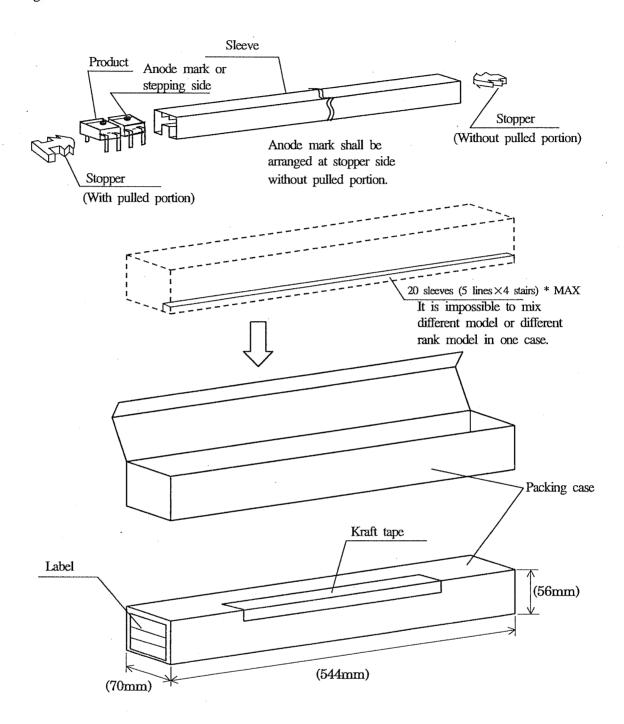
Length: L=520 \pm 2mm

Note 1) Thickness: 0.5 ± 0.2 mm

- 2) Process with applying antistatic treatment.
- 3) Unless otherwise specified tolerances shall be $\pm 0.5 \mathrm{mm}$. (However except for deformation due to the rubber stopper in sleeve.)

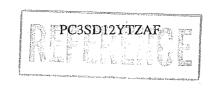


6.2.4. Packing case outline dimensions



Regular packing mass: Approx. 760g

() : Reference dimensions



- 1. This specification shall be applied to photocoupler, Model No. 3SD12 series as an option.
- 2. Applicable Models (Business dealing name)

PC3SD12YTZAF

3. The relevant models are the models Approved by VDE according to DIN EN 60747-5-2.

Up to date code "RD" (December 2003), the relevant models are approved by VDE according to DIN VDE 0884/08.87.

Approved Model No.: 3SD12

VDE approved No.: 40008189 (According to the specification DIN EN 60747-5-2)

Operating isolation voltage U_{IORM (Peak)}: 890V

• Transient voltage : 9000V

• Pollution: 2

• Clearances distance (Between input and output): 6.4 mm (MIN.)

• Creepage distance (Between input and output): 6.4 mm (MIN.)

• Isolation thickness between input and output: 0.15 mm (MIN.)

• Tracking-proof: CTI 175

· Safety limit values

Current (Isi): 200mA (Diode side)

Power (Psi) : 400mW (Phototransistor side)

Temperature (Tsi): 150°C

In order to keep safety electric isolation of photocoupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

· Indication of VDE approval "



" is printed on the minimum packing box.

4. Outline

Refer to the attachment-1-2.

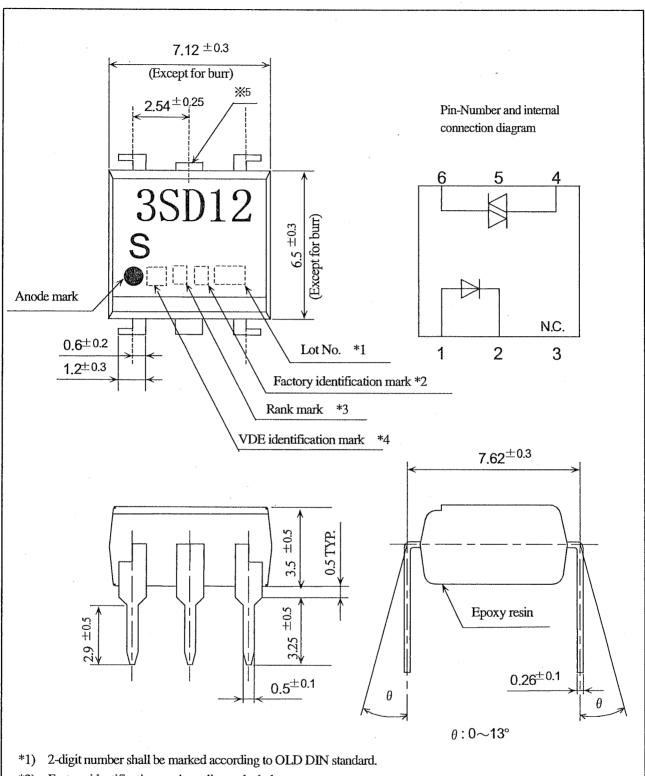
5. Isolation specification according to EN 60747-5-2.

Parameter		Symbol	Conditions	Rating	Unit	Remark		
Class of environmental test			_	DIN IEC68	40/100/21	-		
Pollution				DIN VDE0110	2	-		
Maximum operating isolation voltage		U _{IORM(PEAK)}	-	890	V	Refer to		
Partia	l discharge tes	t voltage					the Dia-	
(Betw	een input and	output)		·			gram 1, 2	
		Diagram 1	Unr	tp=10 s, qc < 5pC	1340	٧	(Attachment -1-3)	
	Diagram 2		Upr _(PEAK)	tp=1 s, qc<5pC	1670	V	-1-3)	
Maxir	num over-vol	tage	U _{IOTM (PEAK)}	t _{INI} =60 s	9000	V		
Safety	/ maximum ra	tings					D.C.	
	 Case temperature Input current 		Tsi	I _F =0, Pc=0	150	$^{\circ}$	Refer to	
			Isi	Pc=0	200	mA	Fig.1, 2 (Attachment	
	3) Electric	power Fotal power dissipation)	Psi	-	400	mW	-1-3)	
Isolati	Isolation resistance			Ta=Tsi	MIN. 10 ⁹			
(Test v	(Test voltage between input and output;		R_{ISO}	Ta=Topr (MAX.)	MIN. 10 ¹¹	Ω		
	DC 500V)			Ta=25℃	MIN. 10 ¹²			

6. Precautions in performing isolation test

- 6.1 Partial discharge test methods shall be the ones according to the specifications of EN 60747-5-2
- 6.2 Please don't carry out isolation test (V_{iso}) over U_{IOTM}. This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. U_{IOTM}). And there is possibility that partial discharge occurs in operating isolation voltage. (U_{IORM}).





*2) Factory identification mark applies to the below.

Without: SUN-S Corporation(Japan)

: SUN-S Electronic Technology (KUNSHAN) Co. Ltd (China)

- *3) Rank mark: "A"
- *4) VDE identification mark shall be marked "4".
- *5) Any external connection with Pin 5 is not allowable. Pin 5 is cut at outside of package.
- *6) Pin material: Copper Alloy

Pin finish: SnCu plating (Cu: TYP. 2%)

Product mass : Approx.0.35g

Name

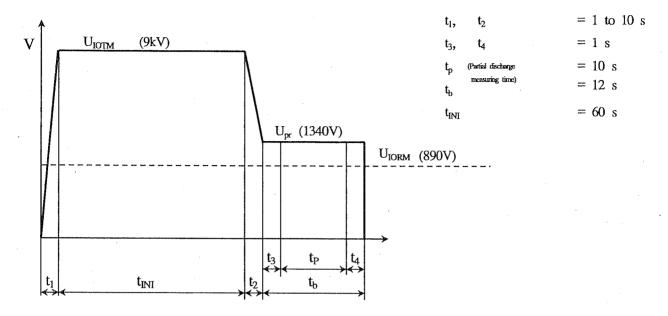
UNIT: 1/1 mm

3SD12

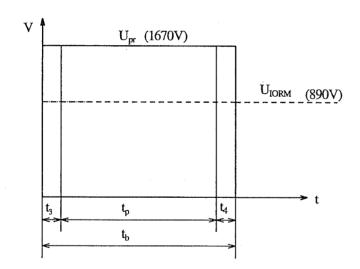
Outline Dimensions
(Business dealing name: PC3SD12YTZAF)



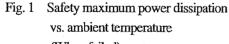
Method of Diagram 1: Breakdown test (Apply to type test and sampling test)



Method of Diagram 2: Non breakdown test (Apply to all device test)



=0.1 s t3, t4 t p (Partial discharge =1 smeasuring time) =1.2 s t_b



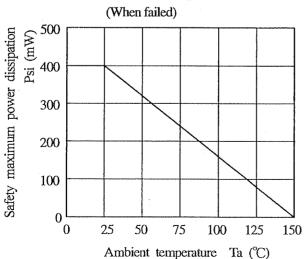


Fig. 2 Safety maximum forward current vs. ambient temperature (When failed)

